



Pb Free

SHOULDER ELECTRONICS LIMITED SPECIFICATION FOR APPROVAL

DATE: 2012-02-21

CUSTOMER	
PRODUCT TYPE	3225 TCXO(2.8V -30/85 ℃ ±0.5ppm 1.2Tmax)
NOMINAL FREQ.	16.368000 MHz
CUSTOMER P/N	N/A
SHOULDER P/N	EX1202-A026(3225TCXO16.368)

[USER]

СНЕСК	СНЕСК	APPROVAL
20	20	20
EXPIRATION DATE	20 .	

[SHOULDER]

СНЕСК	CHECK	APPROVAL
LEO	YORK	PERCY
20	20	20

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REVISIONS HISTORY

Revision No.	Date	Customer Receipt Date	Content	Remark
IR	2012-02-21		First Edition	



SCOPE

This specification is for SMD TCXO(Temperature Compensated Crystal Oscillator).

APPLICATION STANDARDS

MIL-STD-883.

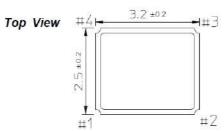
ELECTRICAL SPECIFICATIONS

	D		Electrical S	Electrical Specifications					
	Parameters	MIN	TYP	MAX	UNITS				
Frequency(Fo) ref: 25°	C	16.368000			MHz				
	Vs. Temperature Range	-0.5		+0.5	ppm				
C	Vs. Supply Voltage(±5%)	-0.1		+0.1	ppm				
Frequency Stability	Vs. Load(±10%)	-0.1		+0.1	ppm				
	Vs. Aging(at 25 °C)	-1.0		+1.0	ppm/year				
Frequency Tolerence	Initial Tolerance (at 25°C)	-0.5		+0.5	ppm				
Frequency Tolerence	After 2 Times Reflow (at 25°C)	-1.0		+1.0	ppm				
Operating Temperaue	Range	-30		85	$^{\circ}$				
Storage Temperature F	Range	-40		85	$^{\circ}$				
Supply Voltage			2.8		VDC				
Current Consumption				1.5	mA				
Output Voltage Level		0.8			Vp-p				
Output Waveform			Clipped Sinewave	e					
Output Load									
Slope (1 Frequency rea	ading for every 2°C @-30 to 85°C)	-1.0		+1.0	ppm/°C				
Short term stability (Ta	au=1s)			1	ppb				
Start-up Time(90% of	Vp-p)			2.0	mS				
Duty Cycle		40		60	%				
	10Hz Carrier Offset		-85		dBc/Hz				
	100Hz Carrier Offset		-115		dBc/Hz				
Phase Noise	1KHz Carrier Offset		-135		dBc/Hz				
	10KHz Carrier Offset		-145		dBc/Hz				

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DIMENSIONS(UNIT: mm)



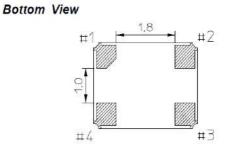
No.	Connection
#1	GND
#2	GND
#3	Output
#4	Vcc

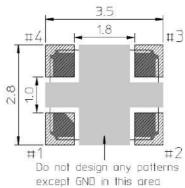
Side View



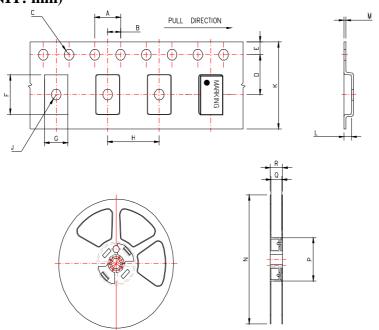
* Recommended Land Pattern (Top View)







PACKING(UNIT: mm)

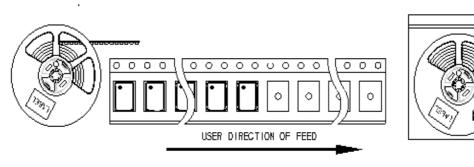


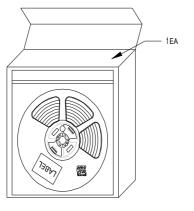
	A	В	С	D	Е	F	G	Н	J	K	L	M	N	P	Q	R	Q'TY
SIZE	8.00	2.00	ф1.50	5.50	1.75	5.35	3.50	8.00	ф1.50	12.0	1.50	0.29	ф178	ф60	13.00	16.00	3000

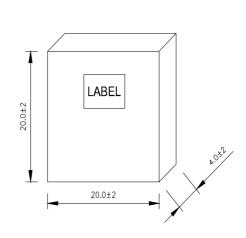
- 1. TOP TAPE START 250mm MINIMUM LEADER AND 160mm EMPTY POCKETS
- 2. END TAPE 250mm MINIMUM EMPTY POCKETS

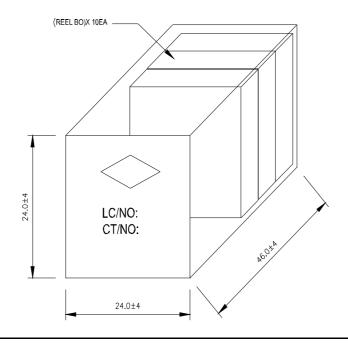


OUTBOX DIMENSIONS(CM)





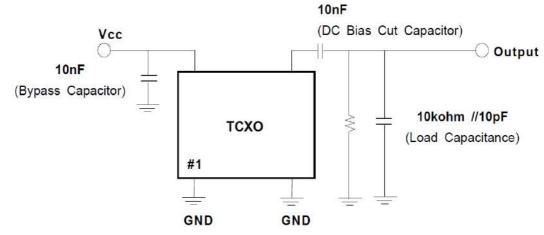






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TEST DIAGRAM



※ Note

- 1. Be cautious of TCXO pin connection.
- 2. Load Capacitance includes probe and test JIG capacitance.

MARKING

KBYML
X-TAL CODE

1. K: Frequency Code

2. B: Control Code

3. Y : Year

4. M: Month

5. L : Date

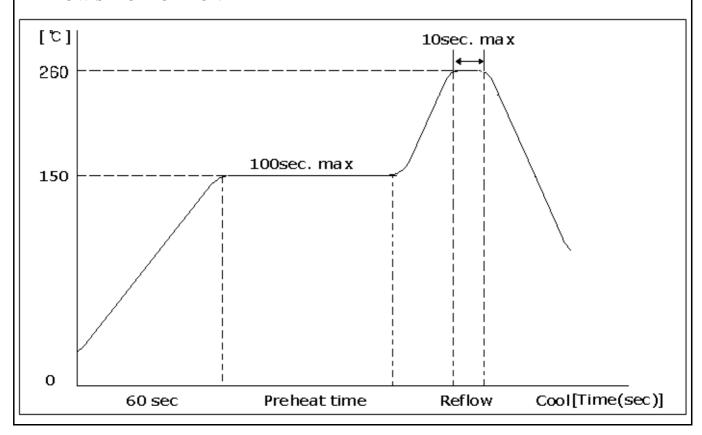


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RELIABILITY SPECIFICATION

NO	ITEMS	CONDITIONS			
1	Solderability	Solder dip at 260 ℃ for 5 seconds			
2	Vibration	20 - $2000\mbox{-}20\mbox{Hz}$, $1.55\mbox{mm}$ total amplitude, each directions(X,Y,Z)/3times 4min			
3	Drop	3 times drop onto hard wooden board from 75cm			
4	High Temp. High Humidity	+45 $^{\circ}$ C ± 2 $^{\circ}$ C, RH=90% $\pm 5\%$ 96 hours minimum			
5	High Tempe. Storage	$+100^{\circ}$ C $\pm 5^{\circ}$ C, 100 hours minimum			
6	Low Tempe. Storage	-55°C±5°C, 100 hours minimum			
7	Thermal Shock	$-25^\circ\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$			
8	Aging	+125 ℃ ±5 ℃, 24 hours minimum			
9	Reflow	+260 °C max, 10sec max			

REFLOW SPECIFICATION





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APPLICATION GUIDELINES

Correct application and strict adherence to the important information listed below, will be ensure optimum performance of the crystal oscillator.

SHOCK RESISTANCE

(Drop test consist of three drops onto a hard wooden board from a height of 75cm)

Nevertheless, under some condition, crystal products may be damaged by drops or

Shocks during mounting.

It is important, therefore, to run mounting machines as smoothly as possible to

Prevent under shocks. Please review conditions prior to using a mounting machine.

VIBRATION RESISTANCE

Mechanical vibration of a piezo buzzer could cause frequency and amplitude Change to the output frequency. It is advisable to use cushion or cutting PCB, if You mount on same PCB.

SOLDERING CONDITION

Please keep the conditions of "Reflow diagram"

STORAGE

We recommend storing products at +15 °C to +35 °C and 25% R.H to 75% R.H